CFSH2-4L

SURFACE MOUNT SILICON SCHOTTKY DIODE



SOD-882L CASE

APPLICATIONS:

- DC-DC converters
- Voltage clamping
- Protection circuits
- Battery powered devices including cell phones, digital cameras, pagers, PDAs, laptop computers, etc.

Central
Semiconductor Corp.

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CFSH2-4L is a high quality Schottky diode designed for applications where ultra small size and power dissipation are prime requirements. Packaged in an SOD-882L package, this component provides performance characteristics suitable for the most demanding size constrained applications.

MARKING CODE: N

FEATURES:

- Device is Halogen Free by design
- Current (I_O=200mA)
- Low Forward Voltage Drop (V_F=0.53V TYP @ 200mA)
- Low Reverse Current (350nA TYP @ 40V)
- Small 1mm x 0.6mm x 0.4mm, ultra low profile, Leadless Surface Mount package.

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Average Forward Current	IO	200	mA
Peak Forward Surge Current, tp=8.3ms	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	100	mW
Operating Junction Temperature	T_J	-65 to +125	°C
Storage Temperature	T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	1000	°C/W

ELECTRICAL CHARACTERISTICS: $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

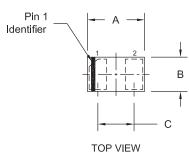
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{R}	V _R =10V		0.08	1.0	μΑ
I_{R}	V _R =40V		0.35	2.0	μΑ
BV_R	I _R =10μA	40			V
V_{F}	I _F =10mA		0.33	0.45	V
V_{F}	I _F =100mA			0.52	V
V_{F}	I _F =200mA		0.53	0.60	V
CJ	V _R =4.0V, f=1.0MHz		7.0	10	pF
t _{rr}	$I_F = I_R = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω		5.0		ns

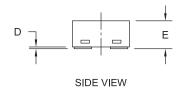
CFSH2-4L

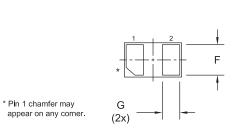
SURFACE MOUNT SILICON **SCHOTTKY DIODE**



SOD-882L CASE - MECHANICAL OUTLINE







BOTTOM VIEW

R2

DIMENSIONS							
MILLIMETERS							
MAX							
1.05							
0.65							
0.65							
0.05							
0.40							
0.55							
0.30							
0							

SOD-882L (REV:R2)

LEAD CODE:

- 1) Cathode 2) Anode

MARKING CODE: N

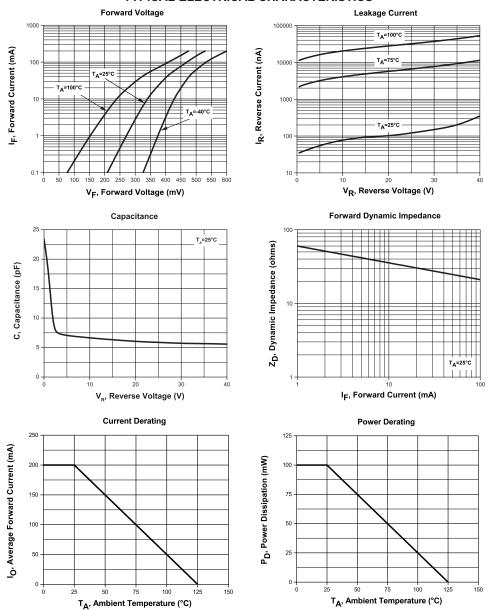
R6 (17-September 2015)

CFSH2-4L

SURFACE MOUNT SILICON SCHOTTKY DIODE



TYPICAL ELECTRICAL CHARACTERISTICS



R6 (17-September 2015)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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